

Title (en)  
METALLISED SECURITY ELEMENT

Title (de)  
METALLISIERTES SICHERHEITSELEMENT

Title (fr)  
ELEMENT DE SECURITE METALLISE

Publication  
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Application  
**EP 05778617 A 20050829**

Priority  

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Abstract (en)  
[origin: US2008094713A1] The invention concerns a security element ( 11 ) in the form of a multi-layer film body, a security document having such a security element and a process for the production of such a security element. The film body on a carrier film ( 10 ) has a release layer ( 20 ), a protective lacquer layer ( 21 ), a replication lacquer layer ( 22 ) with relief structures ( 25, 26 ), a metal layer ( 23 ) and an adhesive layer ( 24 ). A first relief structure ( 25 ) has a depth-to-width ratio of >0.5, whereby the metal layer ( 23 ) is more transparent in the region of the first relief structure ( 25 ). A second relief structure ( 26 ) has a low depth-to-width ratio whereby the metal layer ( 23 ) is less transparent or is opaque in the region of the second relief structure ( 26 ).

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DOCDB simple family (publication)

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AU 2005279328 B2 20100325; BR PI0514730 A 20080624; BR PI0514730 B1 20190625; CA 2578377 A1 20060309; CA 2578377 C 20121218;  
CN 100506561 C 20090701; CN 101035686 A 20070912; DE 102004042136 A1 20060309; DE 102004042136 B4 20061109;  
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EP 1786632 B2 20200722; ES 2338675 T3 20100511; JP 2008511847 A 20080417; JP 5124272 B2 20130123; KR 101287749 B1 20130719;  
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